

1. Record Nr.	UNINA9910556885403321
Titolo	Analog circuits for machine learning, current/voltage/temperature sensors, and high-speed communication : advances in analog circuit design 2021 // Pieter Harpe, Kofi A. A. Makinwa and Andrea Baschiroto, editors
Pubbl/distr/stampa	Cham, Switzerland : , : Springer, , [2022] ©2022
ISBN	3-030-91741-X
Descrizione fisica	1 online resource (351 pages)
Disciplina	006.31
Soggetti	Machine learning Analog integrated circuits Analog integrated circuits - Design and construction
Lingua di pubblicazione	Inglese
Formato	Materiale a stampa
Livello bibliografico	Monografia
Note generali	Includes index.
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